

Electro-Optical Characteristics ($T_a = 25$ °C)

AND7RA

InGaAIP Ultra Bright Red Light Low Profile Surface Mount Package

Features

- 0.40 mm height
- RoHS Compliant
- Compatible with automatic placement equipment.
- Compatible w/ infrared & vapor phase reflow solder process.

Applications

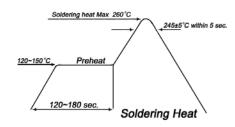
- Backlighting in auto dashboard & switch.
- · Flat backlight for LCD, switch & symbol.
- General use for miniature applications.

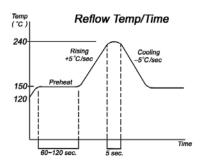
Maximum Ratings $(T_a = 25^{\circ}C)$

Characteristics	Symbol	Rating	Unit
Forward Current	I _F	25	mA
Reverse Voltage	V _R	5	٧
Power Dissipation	P _D	60	mW
Operating Temp. Range	T _{Opr}	-40~ +85	°C
Storage Temp. Range	T _{Stg}	-40~ +90	°C
Soldering Temp. (for 5 seconds)	T _{Sol}	260	°C
Electrostatic Discharge	ESD	2000	٧
Peak Forward Current (Duty 1/10 @ 1KHz)	I _F	60	mA

Characteristics	Symbol	Test Condition	Minimum	Typical	Maximum	Unit
Forward Voltage	V _F	I _F = 5 mA	-	1.6	_	V
Forward Voltage	V _F	I _F = 20 mA	_	2.0	2.4	V
Reverse Current	I _R	V _R = 5 V	_	_	10	μΑ
Luminous Intensity	I _V	I _F = 5 mA	_	45	_	mcd
Luminous Intensity	I _V	I _F = 20 mA	90	135	_	mcd
Peak Wavelength	λ_{P}	I _F = 20 mA	_	632	_	nm
Spectral Line Half Width	Δλ	I _F = 20 mA	-	20	_	nm
Dominant Wavelength	λd	I _F = 20 mA	_	624	_	nm
Full Viewing Angle	2 θ 1/2	I _F = 20 mA	-	120	_	degree

Recommended solder condition



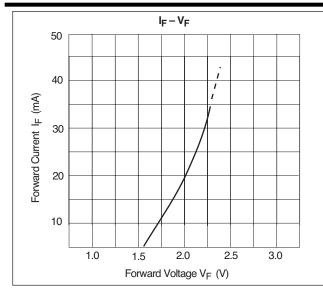


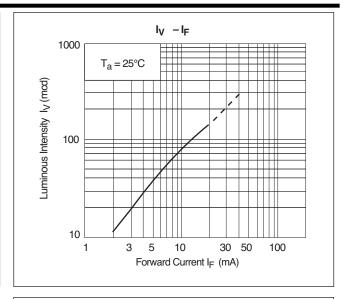
Product specifications contained herein may be changed without prior notice.

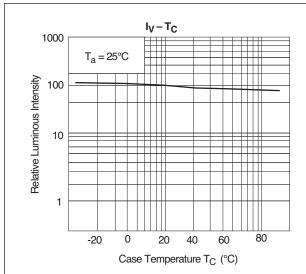
It is therefore advisable to contact Purdy Electronics before proceeding with the design of equipment incorporating this product.

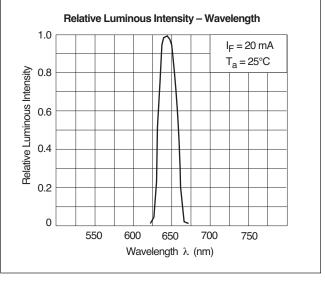


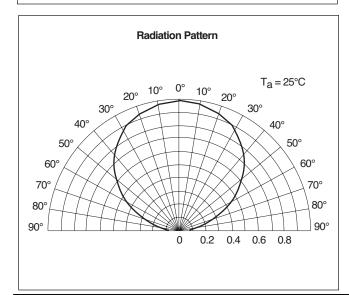
InGaAIP Ultra Bright Red Light

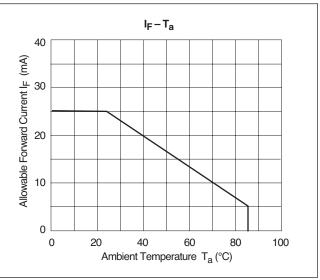


















InGaAIP Ultra Bright Red Light







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